

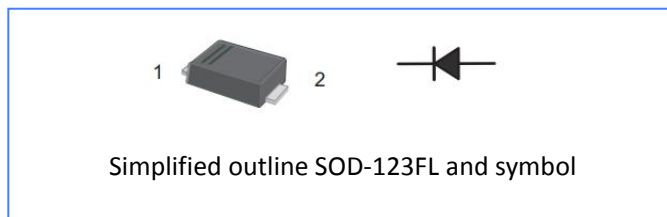
US1AW THRU US1MW

Features

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- High efficiency
- Lead free in comply with EU RoHS 2011/65/EU directives

Mechanical Data

- Case:SOD-123FL
- Terminals: Solderable per MIL-STD-750, Method 20
- Approx. Weight: 15mg/0.00053oz



Pinning

PIN	DESCRIPTION
1	Cathode
2	Anode

Absolute Maximum Ratings And Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	US1AW	US1BW	US1DW	US1GW	US1JW	US1KW	US1MW	Units
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at Tc = 125 °C	I _{F(AV)}	1							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	30							A
Maximum Instantaneous Forward Voltage at 1 A	V _F	1.0			1.3	1.65			V
Maximum DC Reverse Current Ta = 25 °C at Rated DC Blocking Voltage Ta =125 °C	I _R	5 100							μ A
Maximum Reverse Recovery Time ⁽¹⁾	trr	50			75			ns	
Typical Junction Capacitance ⁽²⁾	C _J	15							pF
Typical Thermal Resistance ⁽³⁾	RθJA	85							°C/W
Operating and Storage Temperature Range	T _J , T _{stg}	-55 ~ +150							°C

(1) Measured with $I_F = 0.5\text{ A}$, $I_R = 1\text{ A}$, $t_{rr} = 0.25\text{ A}$

(2) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(3) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas

Rating And Characteristic Curves

Fig.1 Forward Current Derating Curve

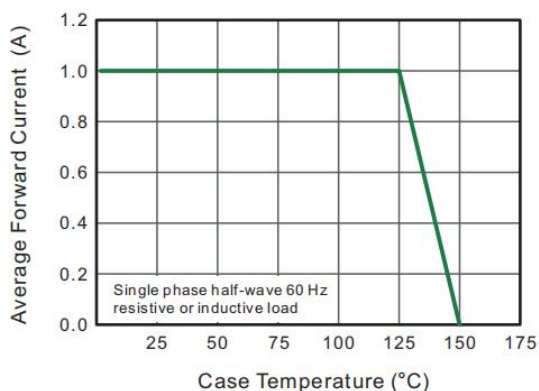


Fig.2 Typical Reverse Characteristics

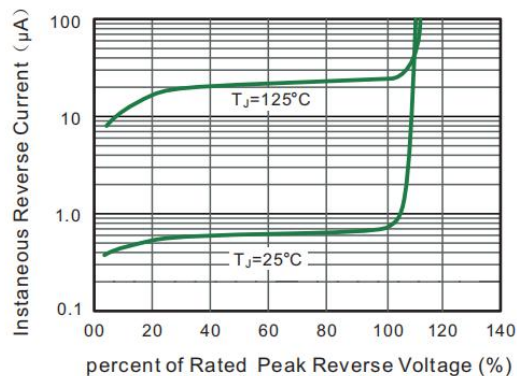


Fig.3 Typical Forward Characteristics

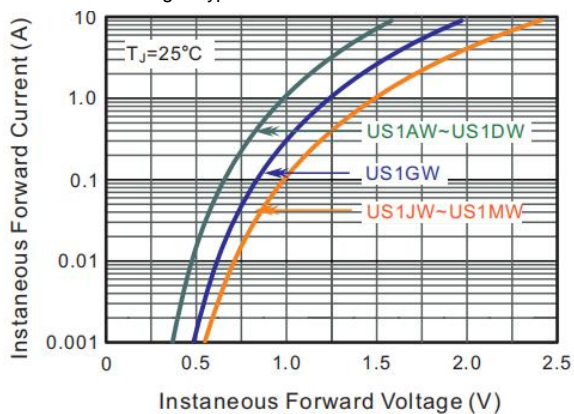


Fig.4 Maximum Non-Repetitive Peak

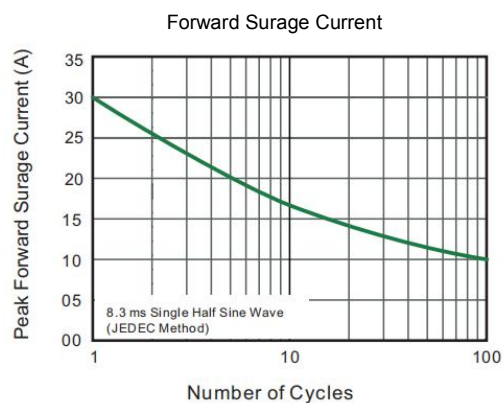


Fig.5 Typical Junction Capacitance

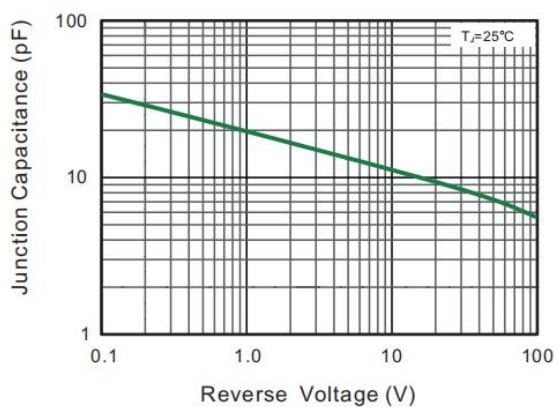
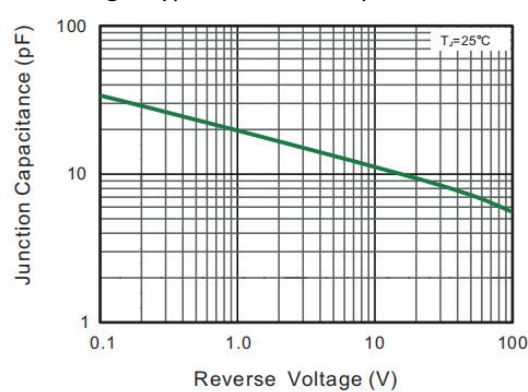


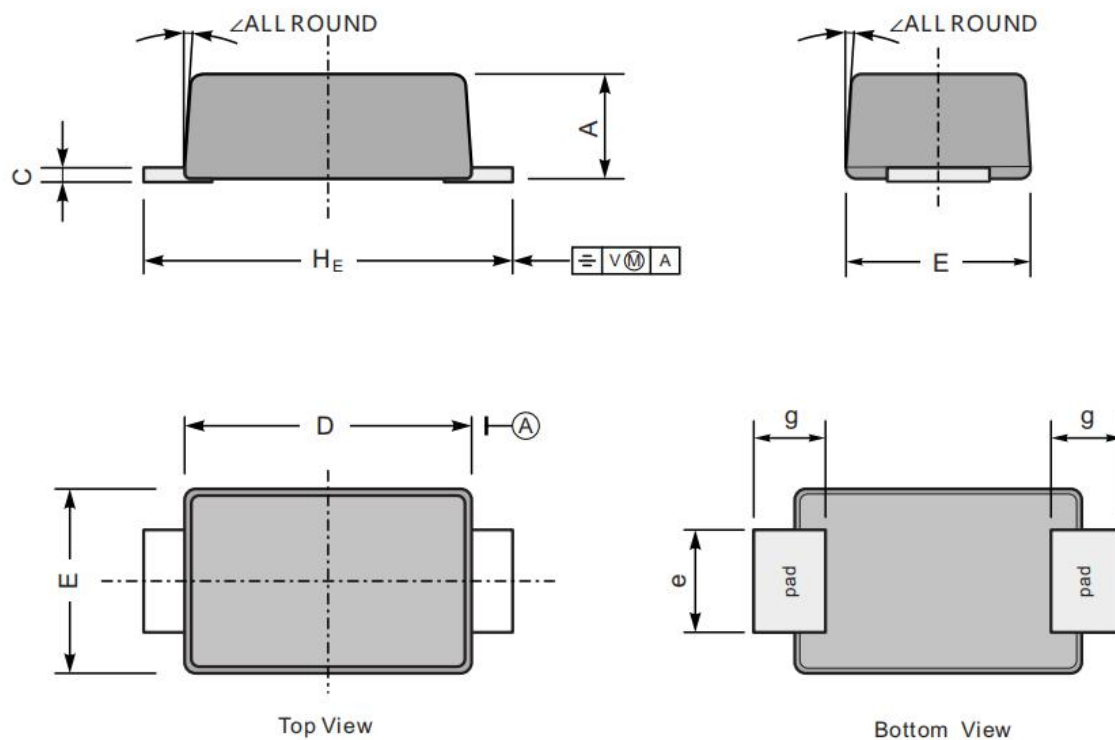
Fig.6 Typical Junction Capacitance



Package Outline

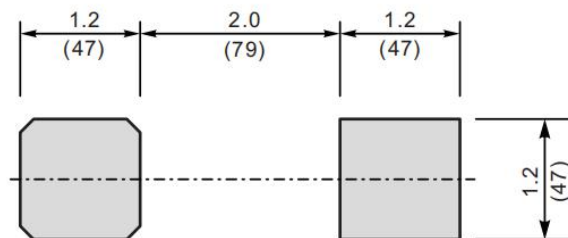
Plastic surface mounted package; 2 leads

SOD-123FL



UNIT		A	C	D	E	e	g	H _E	∠
mm	max	1.1	0.2	2.9	1.9	1.1	0.9	3.8	7°
	min	0.9	0.12	2.6	1.7	0.8	0.7	3.5	
mil	max	43	7.9	114	75	43	35	150	
	min	35	4.7	102	67	31	28	138	

The recommended mounting pad size


Unit: $\frac{\text{mm}}{(\text{mil})}$